

# CEP803AL/CEB803AL

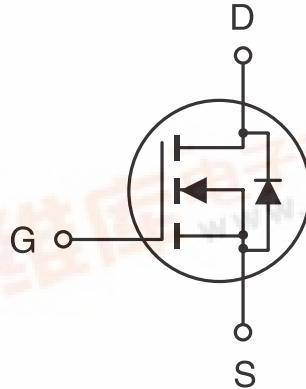
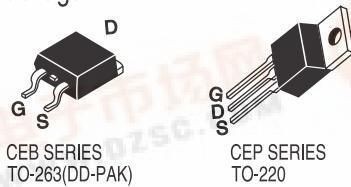
March 1998

## N-Channel Logic Level Enhancement Mode Field Effect Transistor

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### FEATURES

- 30V, 52A,  $R_{DS(ON)}=15\text{m}\Omega$  @  $V_{GS}=10\text{V}$ .  
 $R_{DS(ON)}=25\text{m}\Omega$  @  $V_{GS}=4.5\text{V}$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handling capability.
- TO-220 & TO-263 package.



### ABSOLUTE MAXIMUM RATINGS ( $T_c=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 16$	V
Drain Current-Continuous -Pulsed	$I_D$	52	A
	$I_{DM}$	156	A
Drain-Source Diode Forward Current	$I_S$	52	A
Maximum Power Dissipation <sup>a</sup> @ $T_c=25^\circ\text{C}$ Derate above 25°C	$P_D$	75	W
		0.5	W/°C
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to 175	°C

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case <sup>a</sup>	$R_{\theta JC}$	2	°C/W
Thermal Resistance, Junction-to-Ambient <sup>a</sup>	$R_{\theta JA}$	62.5	°C/W

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## ELECTRICAL CHARACTERISTICS ( $T_c=25^\circ\text{C}$ unless otherwise noted)

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Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	30			V
Zero Gate Voltage Drain Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=24\text{V}, \text{V}_{\text{GS}}=0\text{V}$			10	$\mu\text{A}$
Gate-Body Leakage	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}=\pm 16\text{V}, \text{V}_{\text{DS}}=0\text{V}$			$\pm 100$	nA
<b>ON CHARACTERISTICS<sup>a</sup></b>						
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{th})}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$	1	1.6	3	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS}(\text{ON})}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=26\text{A}$		13	15	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=21\text{A}$		20	25	$\text{m}\Omega$
On-State Drain Current	$\text{I}_{\text{D}(\text{ON})}$	$\text{V}_{\text{GS}}=10\text{V}, \text{V}_{\text{DS}}=10\text{V}$	60			A
Forward Transconductance	$\text{g}_{\text{FS}}$	$\text{V}_{\text{DS}}=10\text{V}, \text{I}_D=26\text{A}$		32		S
<b>DYNAMIC CHARACTERISTICS<sup>b</sup></b>						
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{DS}}=15\text{V}, \text{V}_{\text{GS}}=0\text{V}$ $f=1.0\text{MHz}$		1676	2200	$\text{pF}$
Output Capacitance	$\text{C}_{\text{oss}}$			813	1200	$\text{pF}$
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$			173	230	$\text{pF}$
<b>SWITCHING CHARACTERISTICS<sup>b</sup></b>						
Turn-On Delay Time	$\text{t}_{\text{D}(\text{ON})}$	$\text{V}_{\text{DD}}=15\text{V},$ $\text{I}_D=52\text{A},$ $\text{V}_{\text{GS}}=10\text{V},$ $\text{R}_{\text{GEN}}=24\Omega$		9	16	ns
Rise Time	$\text{t}_r$			190	250	ns
Turn-Off Delay Time	$\text{t}_{\text{D}(\text{OFF})}$			60	90	ns
Fall Time	$\text{t}_f$			175	200	ns
Total Gate Charge	$\text{Q}_g$	$\text{V}_{\text{DS}}=10\text{V}, \text{I}_D=52\text{A},$ $\text{V}_{\text{GS}}=10\text{V}$		35	60	nC
Gate-Source Charge	$\text{Q}_{\text{gs}}$			8		nC
Gate-Drain Charge	$\text{Q}_{\text{gd}}$			5		nC

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## ELECTRICAL CHARACTERISTICS ( $T_c=25^\circ\text{C}$ unless otherwise noted)

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Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>DRAIN-SOURCE DIODE CHARACTERISTICS <sup>a</sup></b>						
Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0\text{V}$ , $I_S = 26\text{A}$		0.86	1.2	V

### Notes

- a. Pulse Test: Pulse Width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
- b. Guaranteed by design, not subject to production testing.

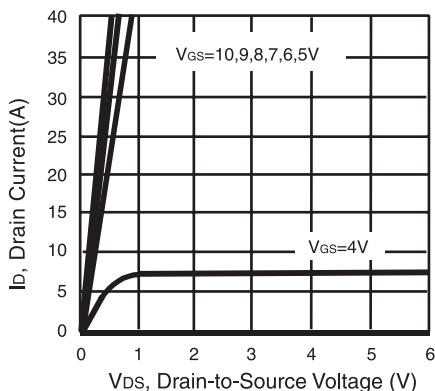


Figure 1. Output Characteristics

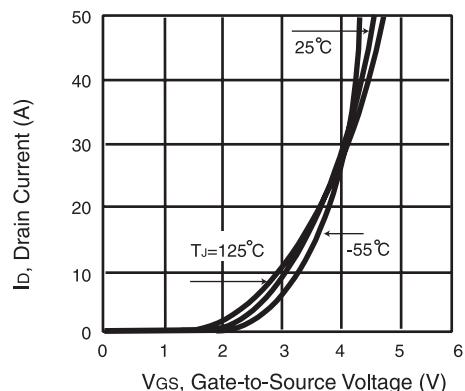


Figure 2. Transfer Characteristics

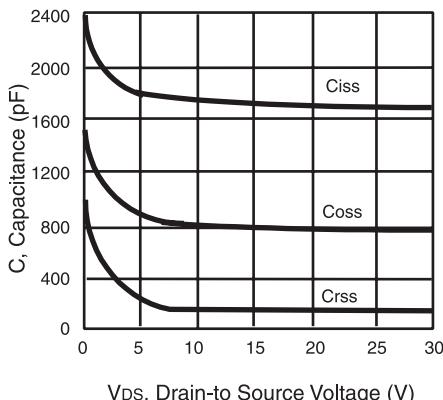


Figure 3. Capacitance

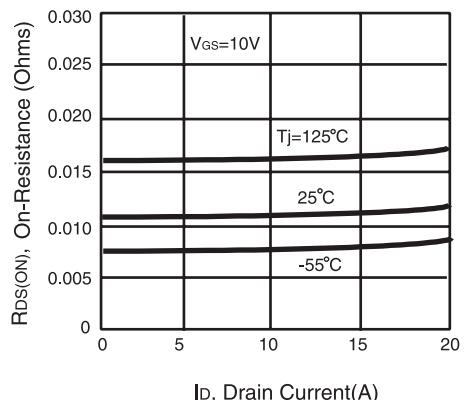
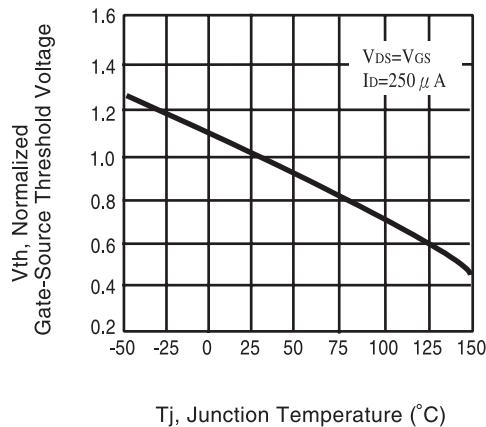
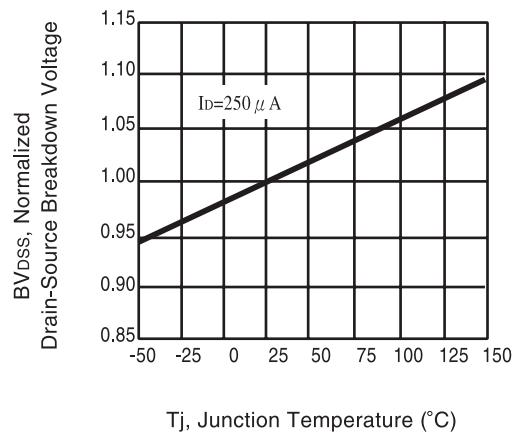


Figure 4. On-Resistance Variation with Drain Current and Temperature

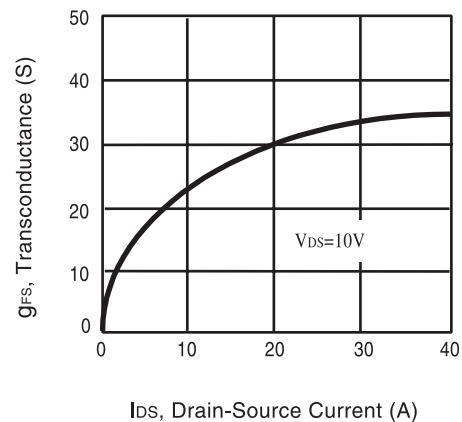
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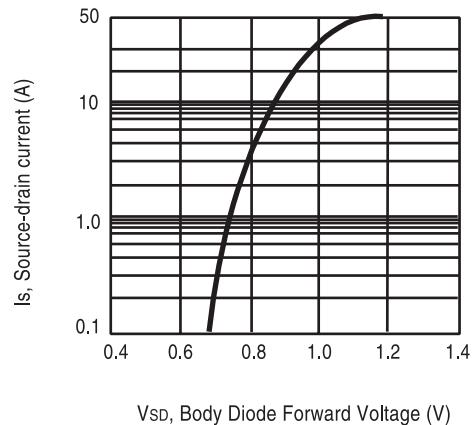
**Figure 5. Gate Threshold Variation with Temperature**



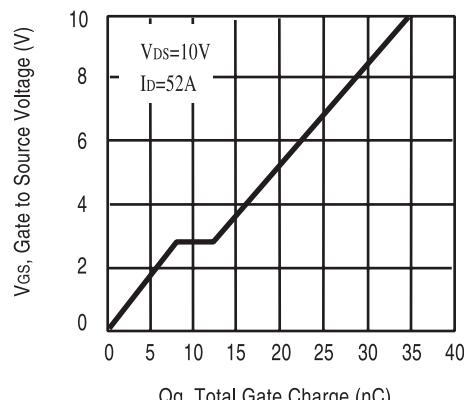
**Figure 6. Breakdown Voltage Variation with Temperature**



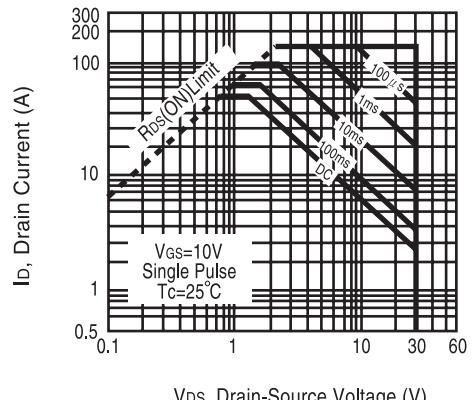
**Figure 7. Transconductance Variation with Drain Current**



**Figure 8. Body Diode Forward Voltage Variation with Source Current**



**Figure 9. Gate Charge**



**Figure 10. Maximum Safe Operating Area**

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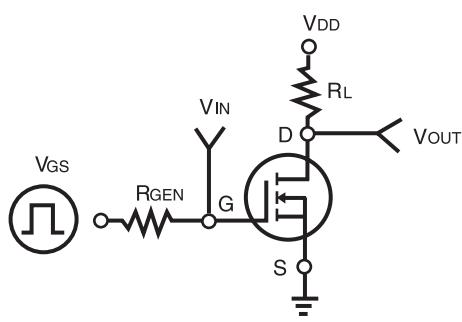


Figure 11. Switching Test Circuit

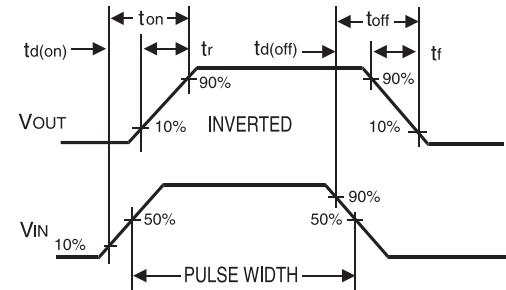


Figure 12. Switching Waveforms

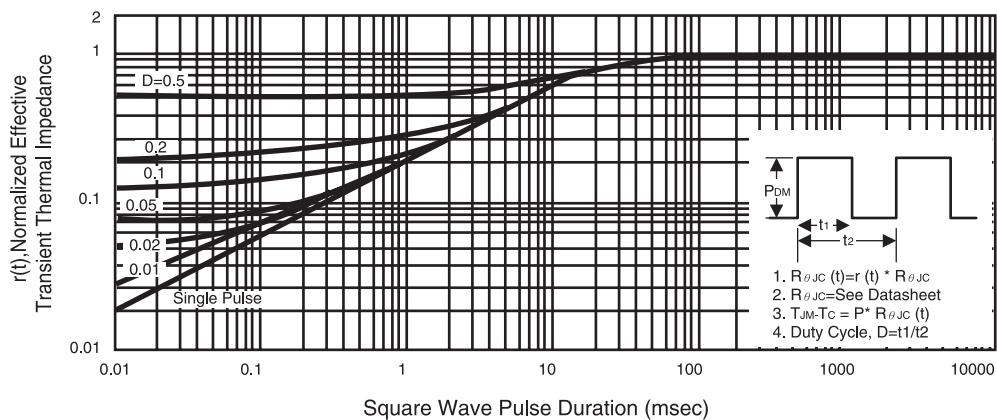


Figure 13. Normalized Thermal Transient Impedance Curve